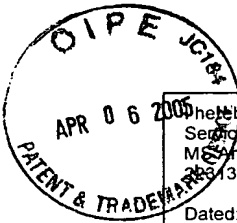


TFW



I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as First Class Mail, in an envelope addressed to: MS Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on the date shown below.  
Dated: April 4, 2005      Signature: [Signature]  
(Michael S. Hun)

Docket No.: 29925/39907  
(PATENT)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of:  
Seong-Wook Kim

Application No.: 10/762,818

Confirmation No.: 6202

Filed: January 22, 2004

Art Unit: 2818

For: METHOD FOR FABRICATING MERGED  
LOGIC CMOS DEVICE

Examiner: Phuc T. Dang

**AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION**

MS Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

**INTRODUCTORY COMMENTS**

In response to the office action mailed on January 4, 2005, please amend the above-identified U.S. patent application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks/Arguments** begin on page 4 of this paper.

**Replacement Drawings** are attached hereto as an appendix.